

- CASE

5th Generation CoolSiC[™] 1200V Schottky Diode

SiC Diode

Features

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / no forward recovery
- Temperature independent switching behaviour
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Pb-free lead plating; RoHS compliant





Pin 1 and backside: Cathode
Pin 2: Anode

Potential applications

- Drives
- Industrial power supplies: Industrial UPS
- Solar central inverters and Solar string inverter

Product validation

• Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

Description

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- Related Links: www.infineon.com/SiC









Key performance parameters

Туре	V _{DC}	I _F	Q c	$T_{vj,max}$	Marking	Package
IDK16G120C5	1200 V	16 A	57nC	175°C	D1612C5	PG-TO263-2



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Maximum ratings

Maximum ratings 1

Note:

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage $T_{\rm C} \ge 25^{\circ}{\rm C}$	V_{RRM}	1200	V
Continuous forward current for $R_{th(j-c,max)}$ $T_C = 145^{\circ}C$, D=1 $T_C = 135^{\circ}C$, D=1 $T_C = 25^{\circ}C$, D=1	I _F	16 19 40	А
Surge repetitive forward current, sine halfwave ¹ T_{c} =25°C, t_{p} =10ms T_{c} =100°C, t_{p} =10ms	I _{F,RM}	64 48	А
Surge non-repetitive forward current, sine halfwave $T_{\rm C}$ =25°C, $t_{\rm p}$ =10ms $T_{\rm C}$ =150°C, $t_{\rm p}$ =10ms	$I_{F,SM}$	140 120	А
Non-repetitive peak forward current $T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10~\mu{\rm s}$	I _{F,max}	850	A
$i^{2}t$ value $T_{C} = 25^{\circ}C$, $t_{p}=10$ ms $T_{C} = 150^{\circ}C$, $t_{p}=10$ ms	∫i²dt	99 71	A ² s
Diode d v /d t ruggedness V_R =0960 V	dv/dt	150	V/ns
Power dissipation for $R_{th(j-c,max)}$ $T_C = 25^{\circ}C$	$P_{ m tot}$	250	W

¹ Not subject to production test. The test was performed with 20000 pulses (two consecutive half-wave rectified sines with 10 ms period).

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Maximum ratings

Operating temperature	$T_{ m vj}$	-55175	°C
Storage temperature	T_{stg}	-55150	°C
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STD-020)	T_{sold}	260	°C

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Thermal resistances

Thermal resistances 2

Davamatav		Conditions	Value			
Parameter	Symbol		min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	$R_{th(j-c)}$		-	0.46	0.60	K/W
Thermal resistance, junction – ambient	$R_{th(j-a)}$	Leaded	-	-	62	K/W

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Electrical Characteristics



Electrical Characteristics

Static Characteristics, at $T_{\nu j}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter			min.	typ.	max.	Oilit
DC blocking voltage	$V_{ m DC}$	$T_{\rm vj} = 25^{\circ}\text{C}, I_{\rm R} = 50 \mu\text{A}$	1200	-	-	V
Diode forward voltage	V_{F}	<i>I</i> _F = 16A, <i>T</i> _{<i>vj</i>} =25°C	-	1.65	1.95	V
		I_F = 16A, T_{vj} =25°C I_F = 16A, T_{vj} =150°C	-	2.25	-	
Reverse current	I _R	V _R =1200V, T _{vj} =25°C	-	5.5	80	μА
		V _R =1200V, T _{vj} =150°C	-	28	-	

Dynamic Characteristics, at $T_{\nu j}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter			min.	typ.	max.	Oilit
Total capacitive charge		V_{R} = 800V, T_{vj} = 150°C				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	57	-	nC
		<i>V</i> _R =1 V, <i>f</i> =1 MHz	-	730	-	
Total Capacitance	С	V _R =400 V, <i>f</i> =1 MHz	-	52	-	pF
		V _R =800 V, <i>f</i> =1 MHz	-	40	-	

Electrical Characteristics Diagrams



4 Electrical Characteristics Diagrams

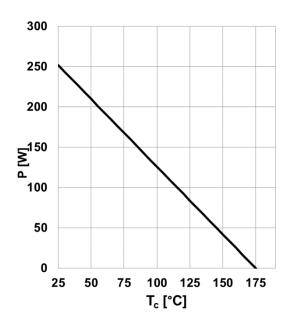


Figure 1. Power dissipation as function of case temperature, $P_{tot}=f(T_c)$, $R_{th(j-c),max}$

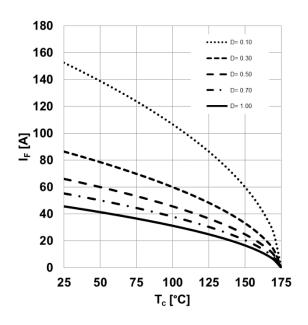


Figure 2. Diode forward current as function of temperature, parameter: T_{vj}≤175°C, R_{th(j-c),max}, D=duty cycle, V_{th}, R_{diff} @ T_{vj}=175°C

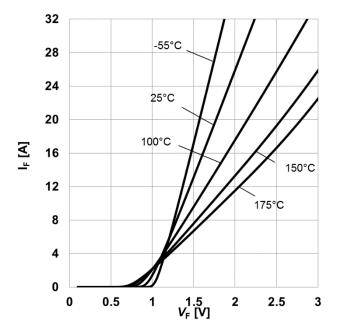


Figure 3. Typical forward characteristics, $I_F = f(V_F)$, $t_p = 10 \mu s$, parameter: T_{vj}

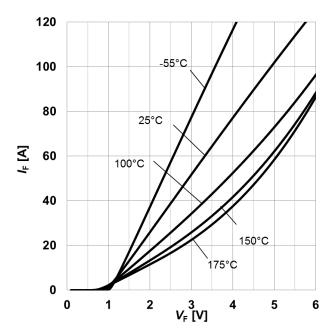


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $I_p=10 \mu s$, parameter: T_{vj}

SiC Diode

Electrical Characteristics Diagrams



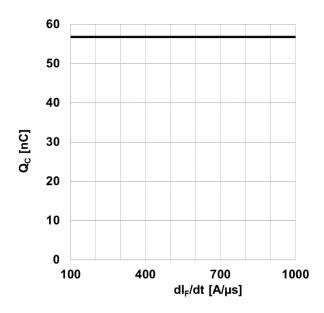


Figure 5. Typical capacitive charge as function of current slope, $Q_c=f(dIF/dt)$, $T_{vi}=150^{\circ}C$

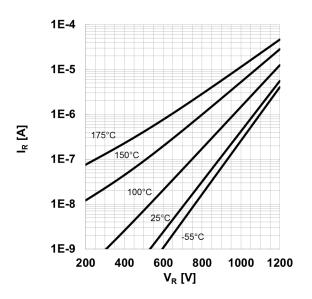


Figure 6. Typical reverse characteristics, $I_R=f(V_R)$, parameter: T_{v_i}

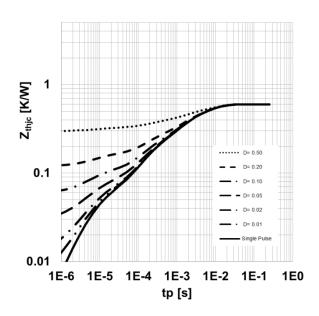


Figure 7. Max. transient thermal impedance, $Z_{th,j-c}=f(t_P)$, parameter: D=tP/T

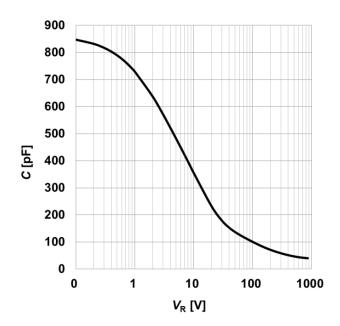


Figure 8. Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_{vi}=25^{\circ}C$; f=1 MHz

SiC Diode

Electrical Characteristics Diagrams



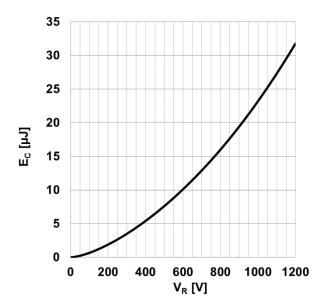


Figure 9. Typical capacitively stored energy as function of reverse voltage, $E_c=f(V_R)$

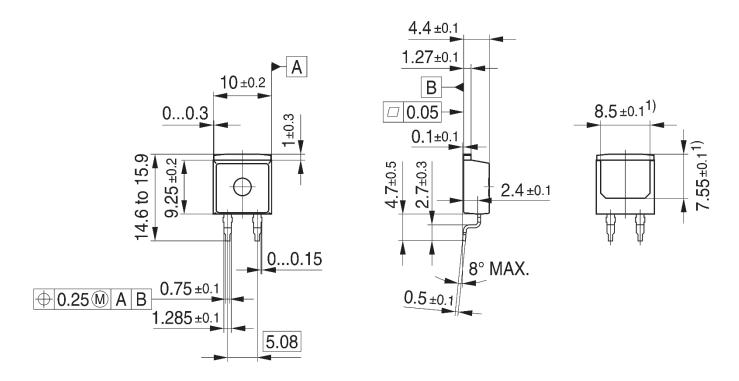
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Package Drawing



5 **Package Drawing**

PG-TO263-2



1) Typical

Metal surface min. X = 7.25, y = 6.9

All metal surfaces: tin plated, except area of cut

All dimensions do not include mold flash or protrusions

All dimensions are in units mm

The drawings is in complicance with ISO 128-30, Projection Method 1 [←♦]

SiC-Diode

Revision history



Revision history

Document version	Date of release	Description of changes
V 2.0	2019-10-28	Final Datasheet
V 2.1	2021-07-14	Increased dv/dt ruggedness

2021-07-14

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Document reference

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